



## 30V N-Channel Trench Power MOSFET

### General Description

The SJB30N090 uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a wide variety of applications.

### Features

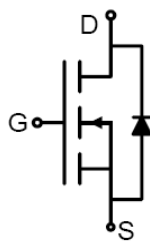
- Low Gate Charge
- High Power and current handling capability
- Lead free product is acquired

### Application

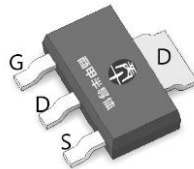
- PWM Applications
- Load Switch
- Power Management

### Key Performance Parameters

Parameter	Value	Unit
$V_{DS}$	30	V
$R_{DS(ON\_TYP)}$	11	mΩ
$I_D$	9.4	A
$Q_G$	12	nC



Schematic Diagram



SOT-223-3L top view



### Package Marking and Ordering Information

Device/Ordering Code	Marking	Package	Packing	Reel Size	Tape width	Quantity
SJB30N090	SJB30N090	SOT-223-3L	Tape	\	\	3000 Pcs

Table 1. Absolute Maximum Ratings ( $T_A=25^{\circ}\text{C}$  unless otherwise noted)

Symbol	Parameter	Limit	Unit
$V_{DS}$	Drain-Source Voltage ( $V_{GS}=0\text{V}$ )	30	V
$V_{GS}$	Gate-Source Voltage ( $V_{DS}=0\text{V}$ )	$\pm 20$	V
$I_D$	Drain Current-Continuous( $T_A=25^{\circ}\text{C}$ )	9.4	A
	Drain Current-Continuous( $T_A=100^{\circ}\text{C}$ )	5.9	A
$I_{DM}$ (pulse)	Drain Current-Continuous@ Current-Pulsed (Note 1)	37.6	A
$P_D$	Maximum Power Dissipation( $T_A=25^{\circ}\text{C}$ )	2	W
	Maximum Power Dissipation( $T_A=100^{\circ}\text{C}$ )	0.8	W
$E_{AS}$	Avalanche energy (Note 2)	42	mJ
$T_J, T_{STG}$	Operating Junction and Storage Temperature Range	-55 To 150	$^{\circ}\text{C}$

Table 2. Thermal Characteristic

Symbol	Parameter	Typ	Max	Unit
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient		63	$^{\circ}\text{C/W}$



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**Table 3. Electrical Characteristics ( $T_J=25^{\circ}\text{C}$  unless otherwise noted)**

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
On/Off States						
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V I <sub>D</sub> =250μA	30			V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> =30V, V <sub>GS</sub> =0V T <sub>J</sub> =25℃			1	μA
		V <sub>DS</sub> =30V, V <sub>GS</sub> =0V T <sub>J</sub> =125℃			100	μA
I <sub>GSS</sub>	Gate-Body Leakage Current	V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V			±100	nA
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA	1		2.5	V
g <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> =5V, I <sub>D</sub> =5A		10		S
R <sub>DS(ON)</sub>	Drain-Source On-State Resistance	V <sub>GS</sub> =10V, I <sub>D</sub> =5A T <sub>J</sub> =25℃		11	14.3	mΩ
R <sub>DS(ON)</sub>	Drain-Source On-State Resistance	V <sub>GS</sub> =4.5V, I <sub>D</sub> =4A T <sub>J</sub> =25℃		17	22.6	mΩ
Dynamic Characteristics						
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> =15V, V <sub>GS</sub> =0V, f=1.0MHz		733		pF
C <sub>oss</sub>	Output Capacitance			13.5		pF
C <sub>rss</sub>	Reverse Transfer Capacitance			5		pF
R <sub>g</sub>	Gate resistance	V <sub>GS</sub> =0V, V <sub>DS</sub> =0V, f=1.0MHz		1.4		Ω
Switching Parameters						
t <sub>d(on)</sub>	Turn-on Delay Time	V <sub>GS</sub> =10V, V <sub>DS</sub> =15V, R <sub>L</sub> =3Ω, R <sub>GEN</sub> =6Ω		4.5		nS
t <sub>r</sub>	Turn-on Rise Time			4		nS
t <sub>d(off)</sub>	Turn-Off Delay Time			20		nS
t <sub>f</sub>	Turn-Off Fall Time			4		nS
Q <sub>g</sub>	Total Gate Charge	V <sub>GS</sub> =10V, V <sub>DS</sub> =15V, I <sub>D</sub> =5A		12		nC
Q <sub>gs</sub>	Gate-Source Charge			2.2		nC
Q <sub>gd</sub>	Gate-Drain Charge			2.5		nC
Source-Drain Diode Characteristics						
I <sub>SD</sub>	Source-Drain Current (Body Diode)				9.4	A
V <sub>SD</sub>	Forward on Voltage (Note 3)	V <sub>GS</sub> =0V, I <sub>S</sub> =5A			1.2	V
t <sub>rr</sub>	Reverse Recovery Time	I <sub>F</sub> =5A, dI/dt=100A/μs		5		ns
Q <sub>rr</sub>	Reverse Recovery Charge	I <sub>F</sub> =5A, dI/dt=100A/μs		6		nC

Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature.

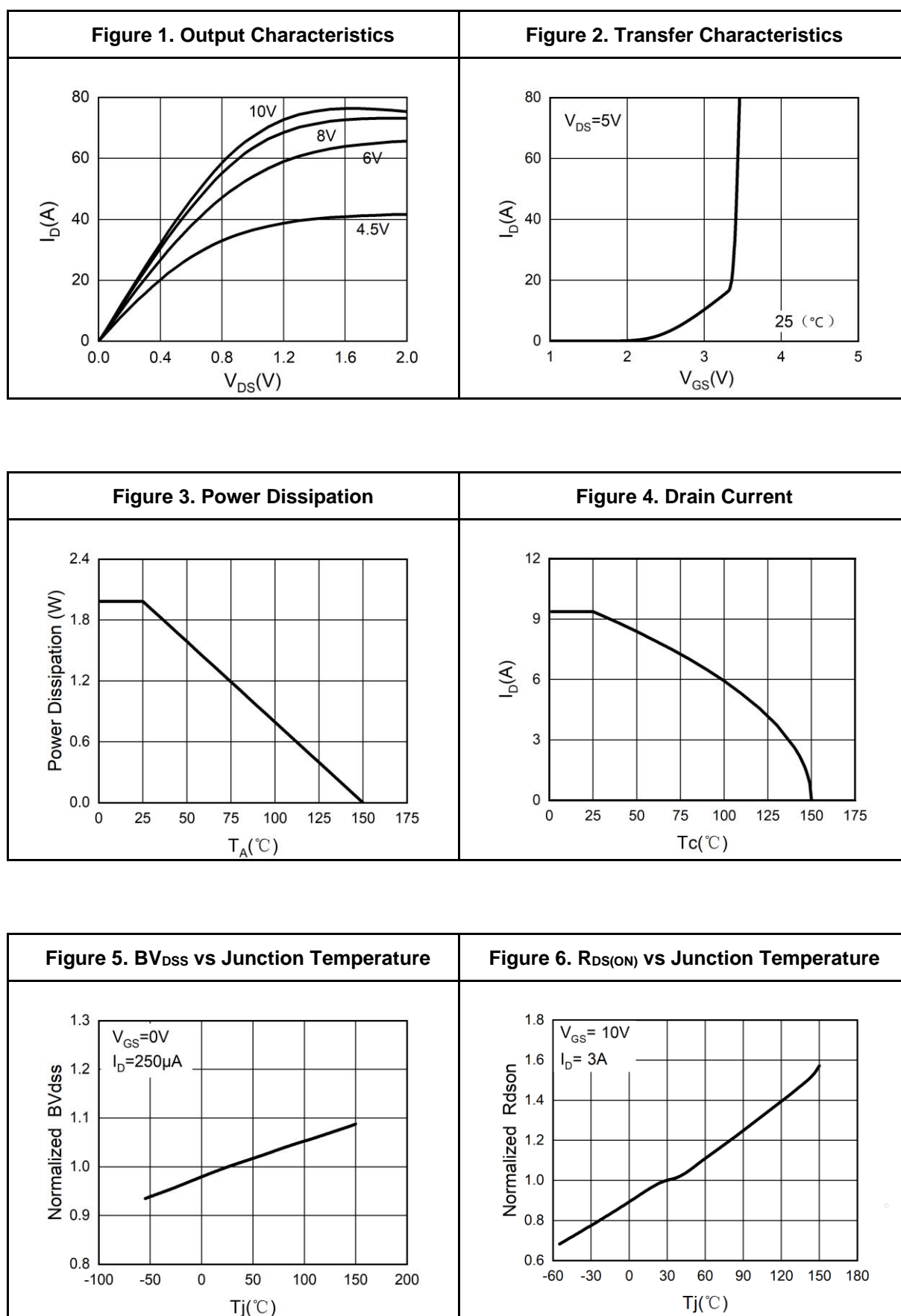
Notes 2. $E_{AS}$  condition:  $T_J=25^{\circ}\text{C}, V_{DD}=30V, V_G=10V, R_g=25\Omega, L=0.5\text{mH}$ .

Notes 3.Repetitive Rating: Pulse width limited by maximum junction temperature.



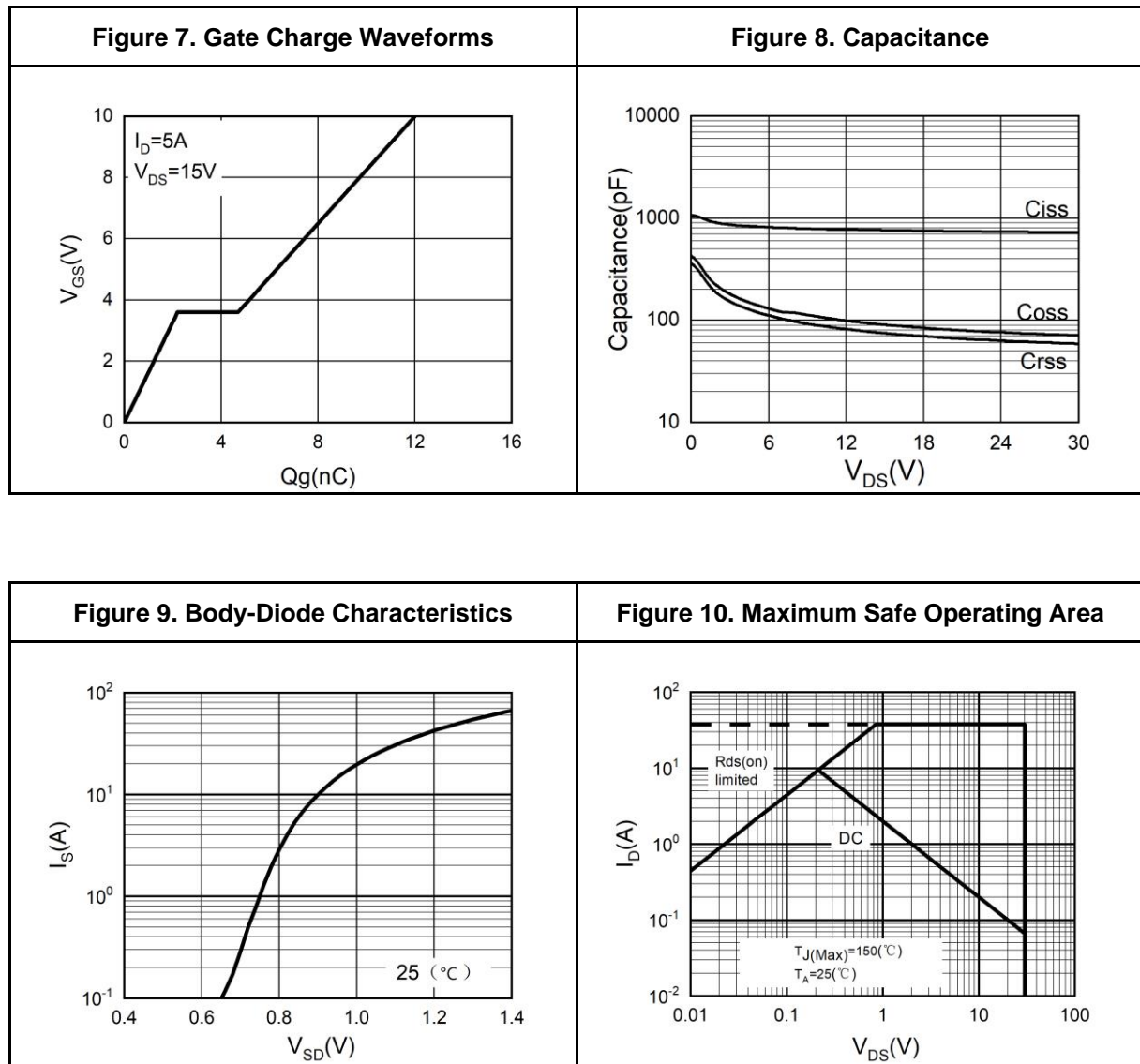
## 30V N-Channel Trench Power MOSFET

### Typical Electrical And Thermal Characteristics (Curves)



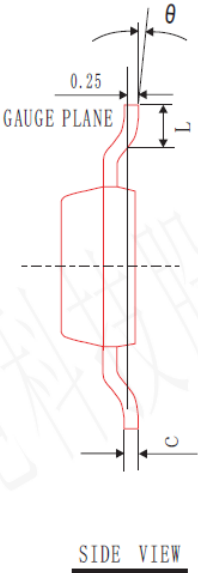
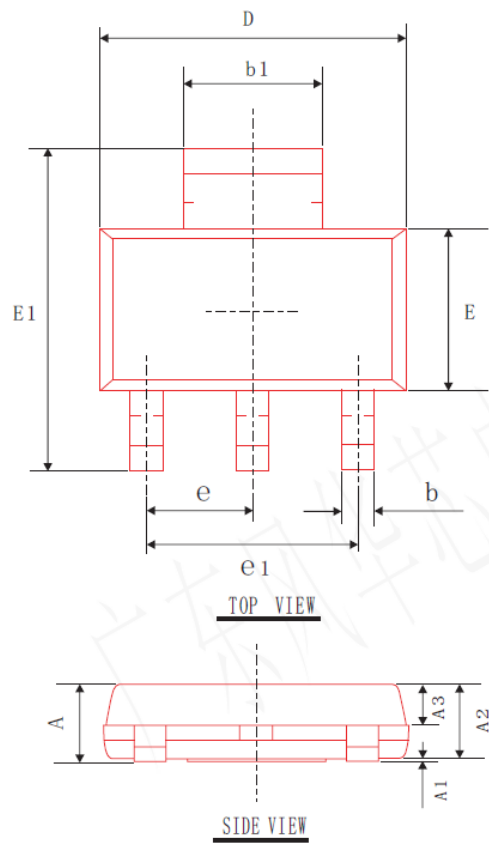


## Typical Electrical And Thermal Characteristics (Curves)





SOT-223-3L Package Information



COMMON DIMENSIONS  
(UNITS OF MEASURE=mm)

SYMBOL	MIN	NOM	MAX
A	—	—	1.80
A1	0.00	0.05	0.10
A2	1.50	1.60	1.70
A3	0.85	0.90	0.95
b	0.66	0.70	0.80
b1	2.96	3.00	3.10
c	0.25	0.30	0.35
D	6.30	6.50	6.70
E	3.30	3.50	3.70
E1	6.80	7.00	7.20
e1	4.40	4.60	4.80
L	0.90	—	1.15
$\theta$	0°	5°	10°
e	2.3 BSC		



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### Attention

This product described in this document can not be used in life support devices or systems, aircraft's control systems, and other applications whose failure can be reasonably expected to result in serious physical and/or material damage, apart from that when an application agreement is signed between customer and Wuxi Shangjia Semiconductor

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